

# **DB101 thru DB107**

## **GLASS PASSIVATED BRIDEG RECTIFIERS**

# REVERSE VOLTAGE - 50 to 1000 Volts

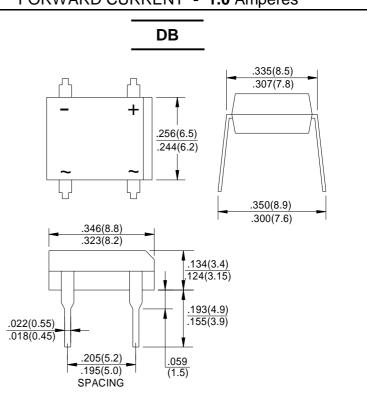
FORWARD CURRENT - 1.0 Amperes

#### **FEATURES**

- Rating to 1000V PRV
- Ideal for printed circuit board
- Low forward voltage drop, high current capability
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- Lead tin Pb/Sn copper
- The plastic material has UL flammability classification 94V-0

#### MECHANICAL DATA

- Polarit: As marked on Body
- Weight: 0.02 ounces, 0.38 gras
- Mounting position: Any



Dimensions in inches and (millimeters)

## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave ,60Hz, resistive or inductive load.

#### For capacitive load, derate current by 20%

CHARACTERISTICS	SYMBOL	DB101	DB102	DB103	DB104	DB105	DB106	DB107	UNIT
Maximum Recurrent Peak Reverse Voltage	Vrrm	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	Vrms	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @Ta=40°C	I(AV)	/) 1.0							А
Peak Forward Surage Current 8.3ms Single Half Sine-Wave Super Imposed on Rated Load (JEDEC Method)	IFSM	тѕм 50							A
Maximum Forward Voltage at 1.0A DC	VF	1.1					V		
Maximum DC Reverse Current@Tj=25°Cat Rated DC Bolcking Voltage@Tj=125°C	lr	10 500							uA
I <sup>2</sup> t Rating for Fusing(t<8.3ms)	l <sup>2</sup> t	10.4						A <sup>2</sup> s	
Typical Junction Capacitance Per Element(Note1)	CJ	25						pF	
Typical Thermal Resistance (Note2)	Rejc	40						°C/W	
Operating Temperature Range	TJ	-55 to +150						°C	
Storage Temperature Range	Tstg	-55 to +150						°C	

Note:1.Measured at 1.0MHz and applied reverse voltage of 4.0V DC

2. Thermal resistance from junction to ambient mounted on P.C.B

with 0.5\*0.5"(13\*13mm)copper pads.

# RATING AND CHARACTERISTIC CURVES DB101 thru DB107

